

DETAILED ACTION

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on June 17, 2010 has been entered.

EXAMINER'S AMENDMENT

2. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with JACQUES L. ETKOWICZ on March 23, 2011.

The application has been amended as follows:

In the Claims:

"the adhesion reinforcing portion is formed on the surface of the substrate, extends continuously between and partly overlaps the pair of electrodes to prevent short circuiting of the pair of electrodes, and the portion other than the electrodes is set on a concave resist film, and the solder part is held in the concave portion," (claim 1, lines 11-15) has been deleted.

"main body" (claim 1, last line) has been changed to: --main body,

wherein the adhesion reinforcing portion is formed on the surface of the substrate, extends continuously between and partly overlaps the pair of electrodes to prevent short circuiting of the pair of electrodes, and a portion of the adhesive other than the adhesive supplied to the electrodes is set on a concave resist film of the adhesion reinforcing portion, and the solder part is held in the concave portion--.

“resist film” (claim 8, line 24) has been changed to: --resist film of the adhesion reinforcing portion--.

Claims 7 and 8 have been canceled.

3. The following is an examiner’s statement of reasons for allowance: the prior art of record fails to teach or suggest the method for mounting an electronic component on the substrate “having a concave resist film the adhesion reinforcing portion is formed on the surface of the substrate, extends continuously between and partly overlaps the pair of electrodes to prevent short circuiting of the pair of electrodes, and forming a solder junction by bonding the connection terminal and electrode by fusing the solder particles in the adhesive supplied to the electrode, and also forming an adhesion reinforced part for fixing the main body to the substrate by heating and curing the adhesive by sealing the inside of the adhesive with solder part by fusing and solidifying of solder particles contained in” in combination with other limitations as recited in amended claims 1 and 4.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue

fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DONGHAI D. NGUYEN whose telephone number is (571)272-4566. The examiner can normally be reached on Monday-Friday (9:00-6:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Derris H. Banks can be reached on (571)-272-4419. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

DN
March 23, 2011

/Donghai D. Nguyen/
Primary Examiner, Art Unit 3729